

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT7364156

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JORDAN HSU	02/14/2017
YU-KUAN LIN	11/22/2016
SHAU-WEI LU	11/23/2016
CHANG-TA YANG	11/22/2016
PING-WEI WANG	11/22/2016
KUO-HUNG LO	11/23/2016
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
Street Address:	8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17830967
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	2519-0517PUS3
NAME OF SUBMITTER:	CANDICE LEE
SIGNATURE:	/Candice Lee/
DATE SIGNED:	06/03/2022

Total Attachments: 3

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ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) _____
SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

The PATENT RIGHTS referred to in this agreement are:

(check one) ☐ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

☒ U.S. patent application Serial No. 15/354,052, filed November 17, 2016

☐ a U.S. patent application based on PCT International Application No. _____ filed on (date) _____ (U.S. patent application Serial No. _____, if known).

☐ U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) ☒ U.S. patent rights only.

☐ Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.

(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN 300, R.O.C.

The ASSIGNEE is:

(check one) ☐ An individual.

☐ A Partnership.

☒ A Corporation of TAIWAN, R.O.C. (specify state or country)

☐ (other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
 ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
 INVENTION TITLE: SEMICONDUCTOR DEVICE AND MANUFACTURING
 METHOD THEREOF

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Jordan HSU</u>	<u>Jordan Hsu</u>	<u>2017.2.14</u>
Name of sole or first inventor	Signature	Date
<u>Yu-Kuan LIN</u>		
Name of second inventor, if any	Signature	Date
<u>Shau-Wei LU</u>		
Name of third inventor, if any	Signature	Date
<u>Chang-Ta YANG</u>		
Name of fourth inventor, if any	Signature	Date
<u>Ping-Wei WANG</u>		
Name of fifth inventor, if any	Signature	Date
<u>Kuo-Hung LO</u>		
Name of sixth inventor, if any	Signature	Date

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Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.


Jordan HSU

Name of sole or first inventor

Signature

Date

Yu-Kuan LIN



Nov. 22, 2016

Name of second inventor, if any

Signature

Date

Shau-Wei LU

S. W. Lu

Nov 23, 2016

Name of third inventor, if any

Signature

Date

Chang-Ta YANG

Chang-Ta Yang

Nov. 22, 2016

Name of fourth inventor, if any

Signature

Date

Ping-Wei WANG

Ping-Wei Wang

Nov 22, 2016

Name of fifth inventor, if any

Signature

Date

Kuo-Hung LO

Kuo-Hung Lo

Nov. 23, 2016

Name of sixth inventor, if any

Signature

Date

PATENT

RECORDED: 06/03/2022

REEL: 060095 FRAME: 0802